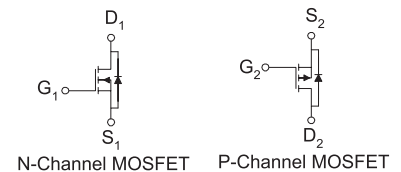
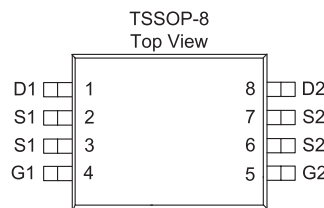


## P & N-Channel 20-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low  $r_{DS(on)}$  and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

- Low  $r_{DS(on)}$  provides higher efficiency and extends battery life
- Low thermal impedance copper leadframe TSSOP-8 saves board space
- Fast switching speed
- High performance trench technology



### PRODUCT SUMMARY

$V_{DS}$ (V)	$r_{DS(on)}$ m( $\Omega$ )	$I_D$ (A)
30	32 @ $V_{GS} = 10V$	4.3
	46 @ $V_{GS} = 4.5V$	3.7
-30	52 @ $V_{GS} = -10V$	-3.8
	80 @ $V_{GS} = -4.5V$	-2.8

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ C$ UNLESS OTHERWISE NOTED)

Parameter		Symbol	N-Channel	P-Channel	Units
Drain-Source Voltage		$V_{DS}$	30	-30	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	$\pm 20$	
Continuous Drain Current <sup>a</sup>	$T_A = 25^\circ C$	$I_D$	4.3	-3.8	A
	$T_A = 70^\circ C$		3.5	-3.0	
Pulsed Drain Current <sup>b</sup>		$I_{DM}$	20	-20	
Continuous Source Current (Diode Conduction) <sup>a</sup>		$I_S$	1.0	-1.0	A
Power Dissipation <sup>a</sup>	$T_A = 25^\circ C$	$P_D$	1.14	1.14	W
	$T_A = 70^\circ C$		0.73	0.73	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	-55 to 150	-55 to 150	$^\circ C$

### THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typ	Max	
Maximum Junction-to-Ambient <sup>a</sup>	$t \leq 10$ sec	$R_{thJA}$	88	110	$^\circ C/W$
	Steady State		120	150	

#### Notes

- Surface Mounted on 1" x 1" FR4 Board.
- Pulse width limited by maximum junction temperature

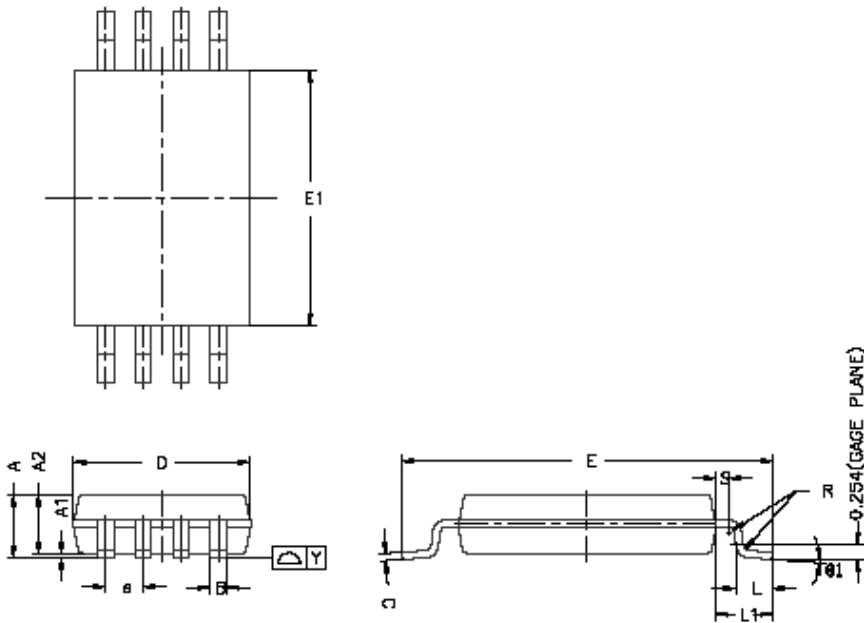
SPECIFICATIONS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)							
Parameter	Symbol	Test Conditions	Limits				Unit
			Ch	Min	Typ	Max	
<b>Static</b>							
Gate-Threshold Voltage	V <sub>GS(th)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 uA	N	1.0			V
		V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = -250 uA	P	-1.0			
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V	N			±100	nA
		V <sub>GS</sub> = -20 V, V <sub>DS</sub> = 0 V	P			±100	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 16 V, V <sub>GS</sub> = 0 V	N			1	uA
		V <sub>DS</sub> = -16 V, V <sub>GS</sub> = 0 V	P			-1	
On-State Drain Current <sup>A</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V	N	20			A
		V <sub>DS</sub> = -5 V, V <sub>GS</sub> = -10 V	P	-20			
Drain-Source On-Resistance <sup>A</sup>	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4.3 A	N			32	mΩ
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 3.7 A				46	
		V <sub>GS</sub> = -10 V, I <sub>D</sub> = -3.8 A	P			52	
		V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -2.8 A				80	
Forward Transconductance <sup>A</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 4.3 A	N		11		S
		V <sub>DS</sub> = -15 V, I <sub>D</sub> = -3.8 A	P		11		
<b>Dynamic</b>							
Total Gate Charge	Q <sub>g</sub>	N-Channel V <sub>DS</sub> = 15V, V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 4.3A	N		4.7		nC
Gate-Source Charge	Q <sub>gs</sub>		P		8.0		
Gate-Drain Charge	Q <sub>gd</sub>	P-Channel V <sub>DS</sub> = -15V, V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -3.8A	N		1.8		nC
			P		2.3		
Turn-On Delay Time	t <sub>d(on)</sub>	N-Chaneel V <sub>DD</sub> = 15V, V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 1A , R <sub>GEN</sub> = 6Ω,	N		13		nS
			P		14		
Rise Time	t <sub>r</sub>	P-Channel V <sub>DD</sub> = -15V, V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -1A R <sub>GEN</sub> = 6Ω	N		14		nS
Turn-Off Delay Time	t <sub>d(off)</sub>		P		14		
Fall-Time	t <sub>f</sub>		N		30		nS
			P		40		
			N		30		
			P		30		

Notes

- a. Pulse test: PW ≤ 300us duty cycle ≤ 2%.
- b. Guaranteed by design, not subject to production testing.

Package Information

TSSOP-8: 8LEAD



DIM.	MILLIMETERS		
	MIN.	NDM.	MAX.
A	1.05	1.10	1.20
A(1)	0.05	0.10	0.15
A(2)	0.99	1.02	1.05
B	0.19	0.25	0.30
C	---	0.127	---
D	2.90	3.00	3.10
E	6.20	6.40	6.60
E1	4.30	4.40	4.50
b	0.6595C		
L	0.45	0.60	0.75
L1	0.90	1.00	1.10
Y	---	---	0.10
Ø1	Ø	Ø	Ø
R	0.09	---	---
S	0.20	---	---